

**200mm Dynamic Wafer Slide Transfer**

The low cost Standard slide transfer model supports the cassettes on an ultra-low friction, low particle slide surface. The cassettes are gently pushed to transfer wafers.

### Product Specifications

Wafer Size	Model No.	Footprint (mm)
<b>Standard</b>		
100mm	ST4	355 × 180
150mm	ST6	558 × 235
200mm	ST8	660 × 292
<b>Dynamic</b>		
100mm	STD-4P	373 × 133
150mm	STD-6P	483 × 152
200mm	STD-8P	683 × 190

### Key Features

- Low particle generation materials to provide Class 1 cleanliness
- Special materials such as Ultem for high temperature requirements
- ESD models available

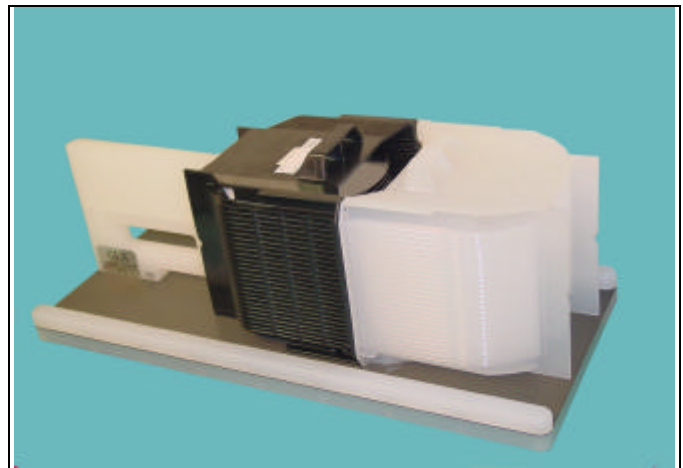
*The GLA wafer slide transfer systems provide safe and quick transfer of wafers.* At various stages of FAB process functions, wafer transfer from cassette to cassette is required. GLA offers two production-proven hand operated wafer transfer models to reliably meet these requirements in a cost-effective manner. The wafer transfer models are manufactured from SEMI approved materials minimizing or eliminating any possibility of particle generation.

Two models of transfer systems are available – Dynamic and Standard Wafer Slide Transfers.

The compact Dynamic slide transfer model supports the sending and receiving cassettes on a moving platform virtually eliminating particle generation. The moving platform will not move until receiving cassette is in position and releases the safety lock. This design has a very small footprint and is easy to use.

### Options

- Cassette Combinations: 200-150mm; 150-125mm
- Cassette Types: STD, Metal, or Reduced height
- Slide Surface on Standard Transfers
- Full Cassette or Partial Cassette Transfers
- Custom designs for unique cassette combinations



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